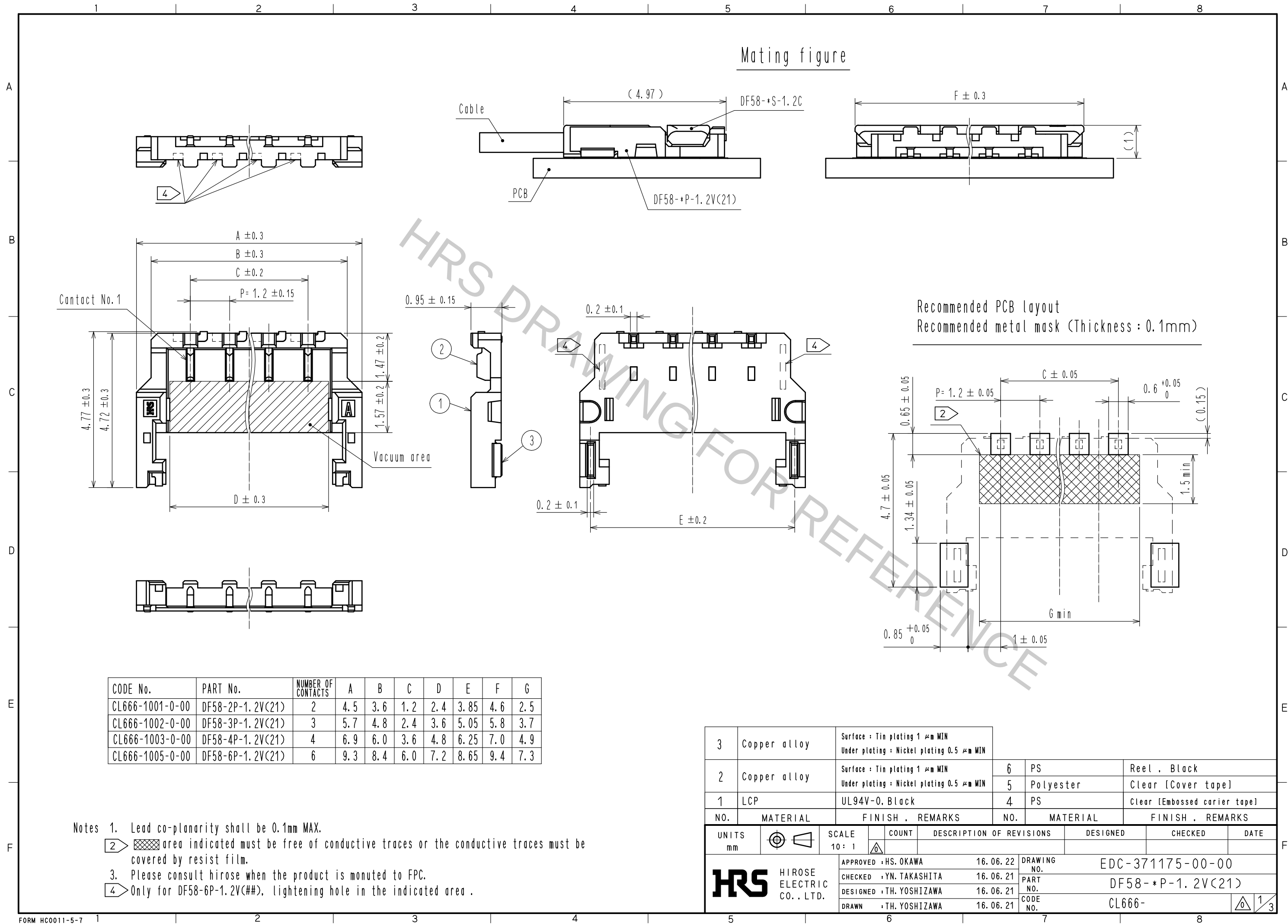
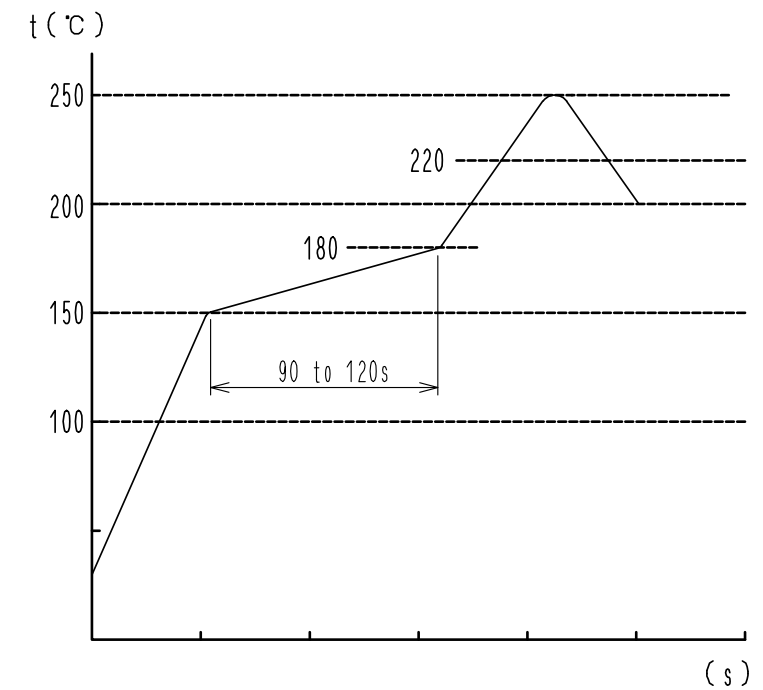


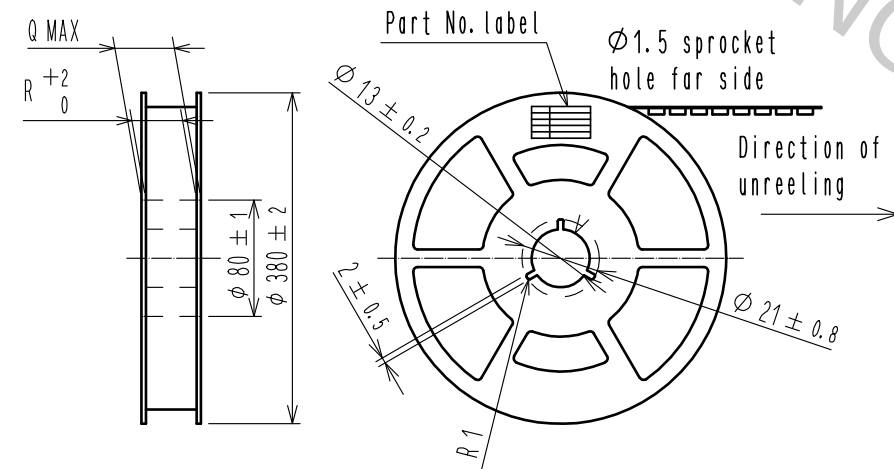


Reflow temperature profile using lead-free solder paste (Reference)



Additional factors, such as solder paste type, PCB size and other mounted components could affect the profile, therefore, a thorough evaluation of mounting condition is required prior to production. Temperature is measured at contact lead.

Style and dimension of reel (Free)



生産月日	年 月 日
図 番	CL666-****-21
品 名	DF58-*P-1.2V(21)
納入数量	6000 K0
納入者	ヒロセ電機(株)

CODE No.	PART No.	NUMBER OF CONTACTS	M	N	P	Q	R
CL666-1001-0-00	DF58-2P-1. 2V(21)	2	16. 0	14. 25	7. 5	22. 4	16. 4
CL666-1002-0-00	DF58-3P-1. 2V(21)	3	16. 0	14. 25	7. 5	22. 4	16. 4
CL666-1003-0-00	DF58-4P-1. 2V(21)	4	24. 0	22. 25	11. 5	30. 4	24. 4
CL666-1005-0-00	DF58-6P-1. 2V(21)	6	24. 0	22. 25	11. 5	30. 4	24. 4



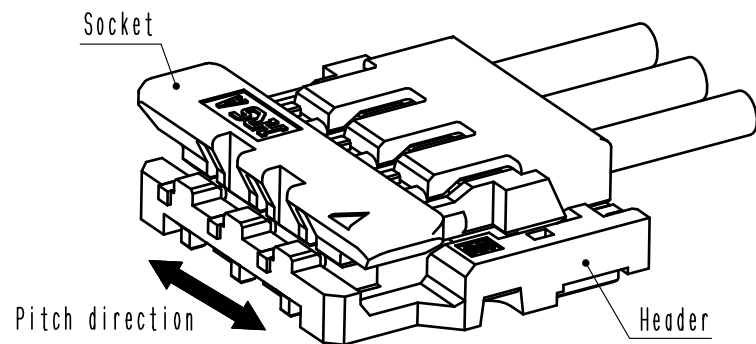
DRAWING NO.	EDC-371175-00-00		
PART NO.	DF58-*P-1.2V<21>		
CODE NO.	CL666-		$\frac{2}{3}$

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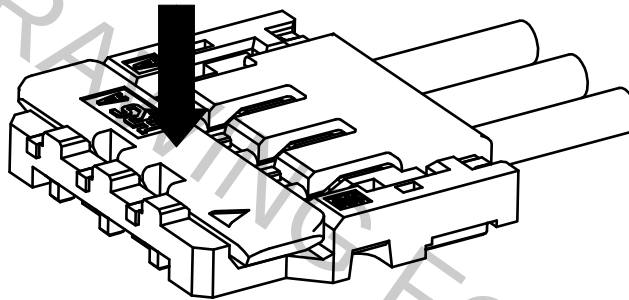
DF58 Series Mating / Unmating Operation Instruction

Mating

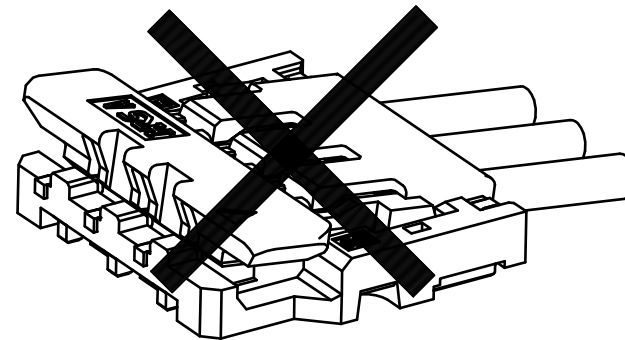
- ① By positioning the convexity of the socket sides to the header concavity, align the centers of the socket and the header in pitch direction.



- ② Slightly press the socket down at the center of the socket.

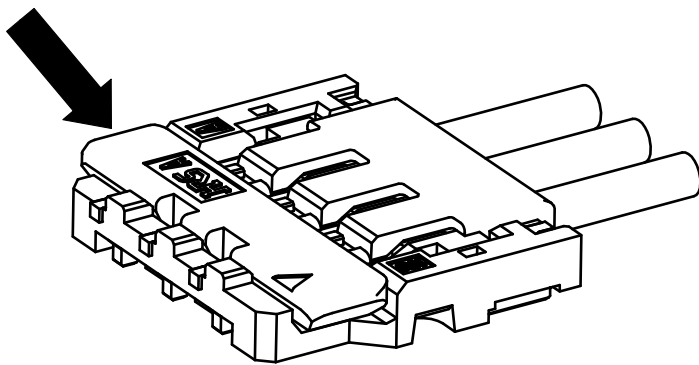


- ③ Press down at the lever side with stabilizing the cable side to insert. Mating completes.

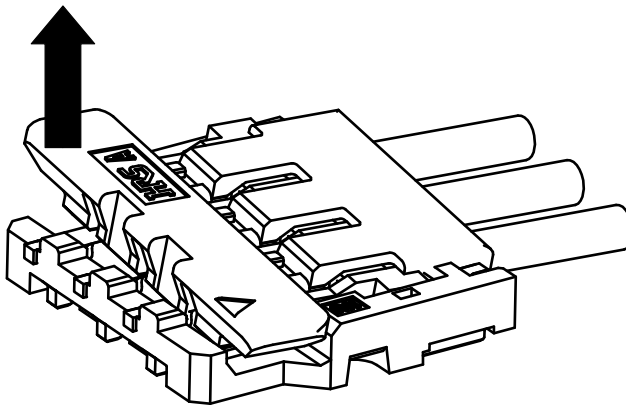


Unmating

- ① Hook the lever with finger nail. (Possible with one side)



- ② Lift up to the upper direction and friction lock is released.



- ③ Lift it up to the upper direction more, and removal completes.

